

DATA SHEET

PCK857

66–150MHz Phase Locked Loop
Differential 1:10 SDRAM Clock Driver

Preliminary specification

1998 Dec 10

66–150MHz Phase Locked Loop Differential 1:10 SDRAM Clock Driver

PCK857

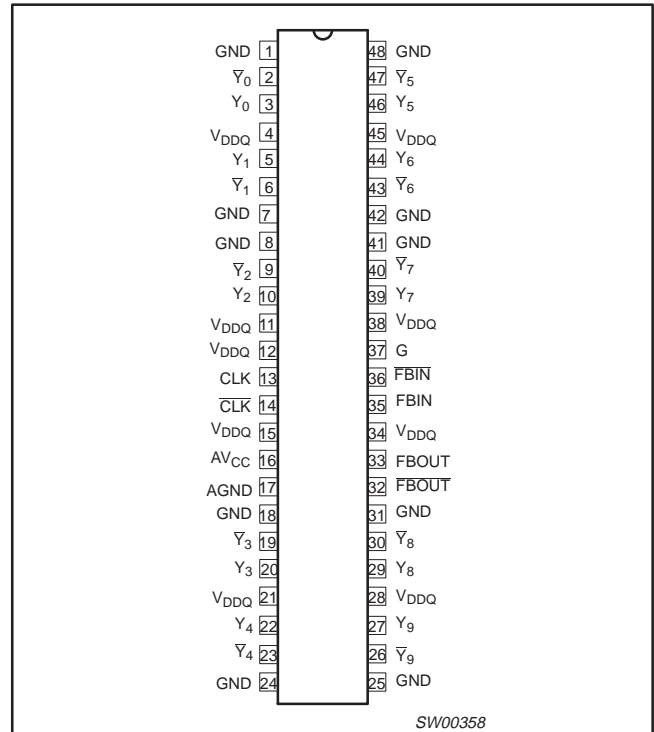
FEATURES

- Optimized for clock distribution in DDR (Double Data Rate) SDRAM applications
- 1-to-10 differential clock distribution
- Very low skew (< 100ps) and jitter (< 100ps)
- 3V AV_{CC} and 2.5V V_{DDQ}
- SSTL_2 interface clock inputs and outputs
- CMOS control signal input
- Test mode enables buffers while disabling PLL
- Low current power-down mode
- Tolerant of Spread Spectrum input clock
- Full DDR solution provided when used with SSTL16857 and CBT3857

DESCRIPTION

Zero delay buffer to distribute an SSTL differential clock input pair to 10 SSTL_2 differential output pairs. Outputs are slope controlled. External feedback pin for synchronization of the outputs to the input. A CMOS style Enable/Disable pin is provided for low power disable.

PIN CONFIGURATION



ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DRAWING NUMBER
48-Pin Plastic TSSOP	0°C to +70°C	PCK857 DGG	PCK857 DGG	SOT362-1

PINS	SYMBOL	DESCRIPTION
1, 7, 8, 18, 24, 25, 31, 41, 42, 48	GND	SSTL_2 ground pins
2, 3, 5, 6, 9, 10, 19, 20, 22, 23, 26, 27, 29, 30, 32, 33, 39, 40, 43, 44, 46, 47	Y _n , Y _{nb} , FB _{OUT} , FB _{OUTb}	SSTL_2 differential outputs
4, 11, 12, 15, 21, 28, 34	V _{DDQ}	SSTL_2 power pins
13, 14, 35, 36	CLK _{IN} , CLK _{INb} , FB _{IN} , FB _{INb}	SSTL_2 differential inputs
16	AV _{CC}	Analog power
17	AGND	Analog ground
37	G	Power-down control input

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FUNCTION TABLE

INPUTS			OUTPUTS				PLL ON/OFF
G	CLK	CLK̄	Y	Ȳ	FBOUT	FBOUT	
L	L	H	Z	Z	Z ¹	Z ¹	OFF
L	H	L	Z	Z	Z ¹	Z ¹	OFF
H	L	H	L	H	L	H	ON
H	H	L	H	L	H	L	ON
X ²	< 20MHz	< 20MHz	Z	Z	Z ¹	Z ¹	OFF

NOTES:

H = HIGH voltage level

L = LOW voltage level

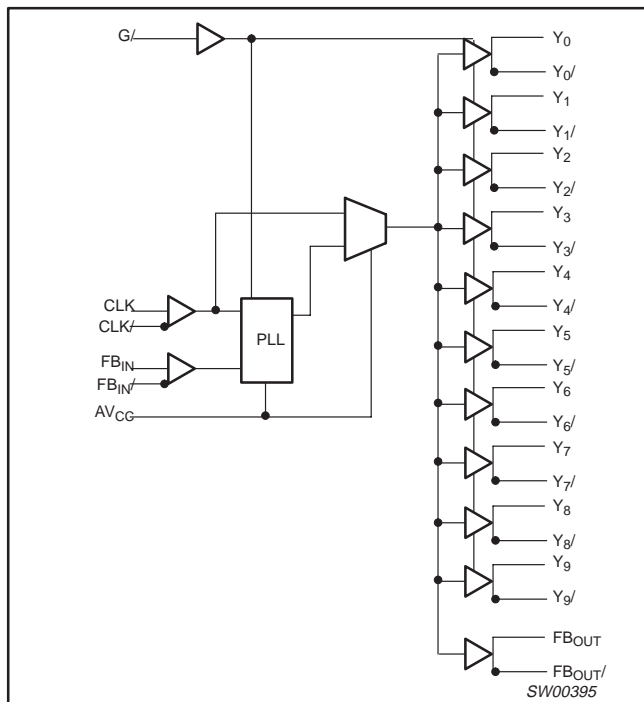
Z = high impedance OFF-state

X = don't care

1. Subject to change. May cause conflict with FBIN pins.

2. Additional feature that senses when the clock input is less than 20MHz and places the part in sleep mode.

BLOCK DIAGRAM



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DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
V_{CC}	Analog supply voltage		3	3.3	3.6	V
V_{DDQ}	I/O supply voltage		2.3	2.5	2.7	V
V_{IL}	Input low voltage		-0.3		$V_{ref} - 0.35$	V
V_{IH}	Input high voltage		$V_{ref} + 0.35$		$V_{ddq} + 0.3$	V
V_{OL}	Output low voltage ¹		0		0.5	V
V_{OH}	Output high voltage ¹		2		V_{ddq}	V

NOTE:

1. This is intended to operate in the SSTL_2 type IV unterminated mode without series resistors on the outputs.

AC CHARACTERISTICS

GND = 0V; $t_r = t_f \leq 2.5\text{ns}$; $C_L = 50\text{pF}$; $R_L = 1\text{K}\Omega$

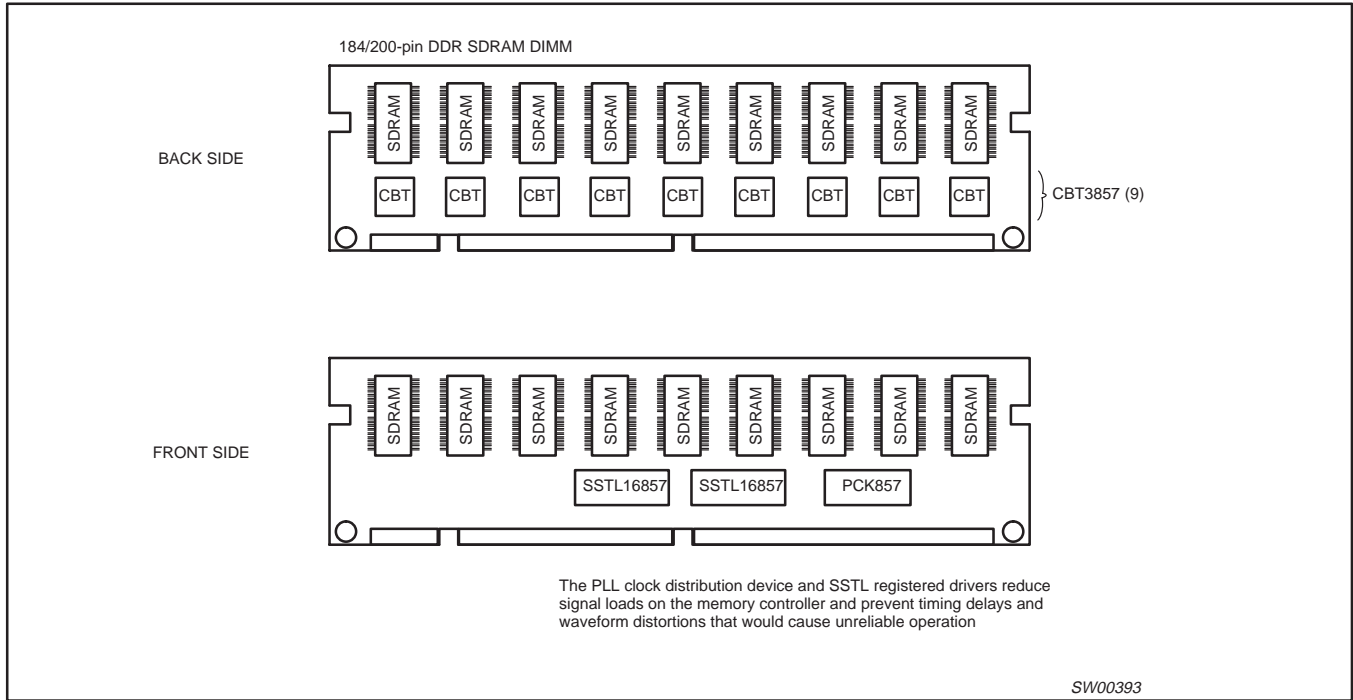
SYMBOL	PARAMETER	WAVEFORM	CONDITION	LIMITS			UNIT
				MIN	TYP	MAX	
f_{CK}	Clock frequency			50	133	150	MHz
$f_{PHASERROR}$	Phase error			-150	0	150	ps
f_{SK}	Output clock skew					200	ps
f_{difSK}	Differential clock skew					100	ps
f_{SL}	Output clock skew			1	1.5		V/ns
Jitter _{pp}	Peak-to-Peak jitter (long term)			-100		100	ps
Jitter _{cc}	Cycle-to-cycle jitter (short term)			> -100		< 100	ps
O/P impedance	Inherent series resistance				25		Ω
f_{DC}	Duty cycle			45		55	%
C_{in}	Input capacitance			2.5		4	pF
Sync time						100	μs

NOTE:

1. Rise and fall

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AC WAVEFORMS

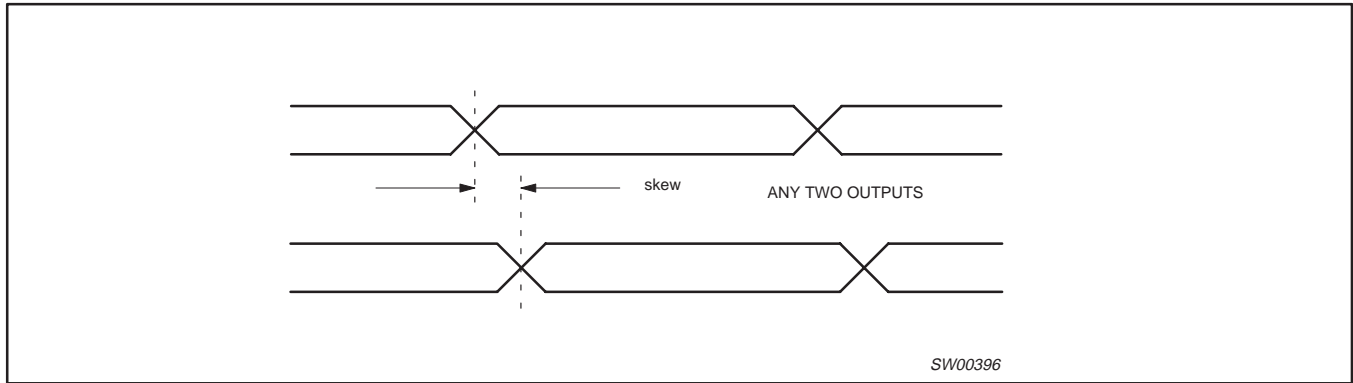


Figure 1. Skew between any two outputs.

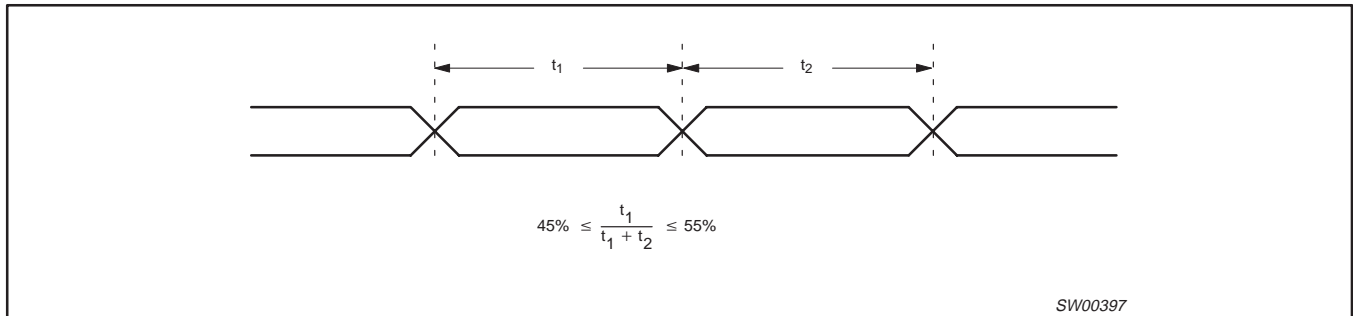


Figure 2. Duty cycle limits and measurement

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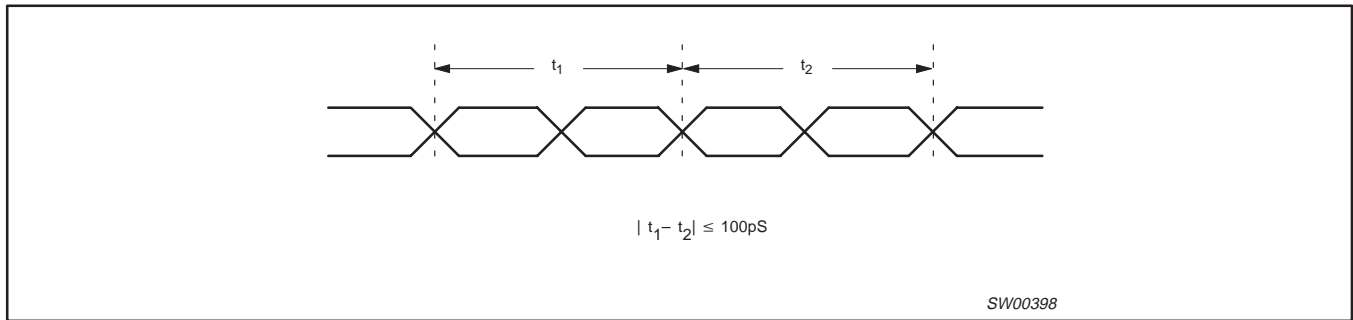
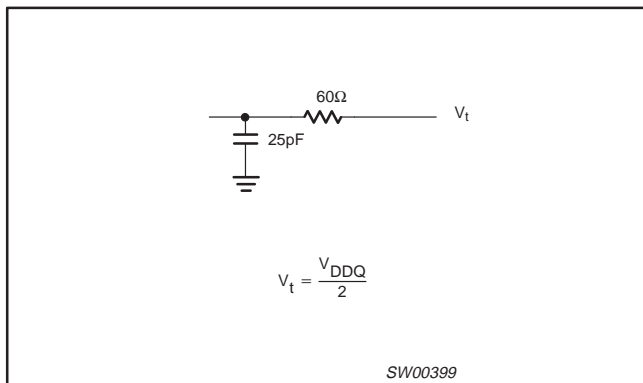


Figure 3. Jitter limit and measurement

TEST CIRCUIT

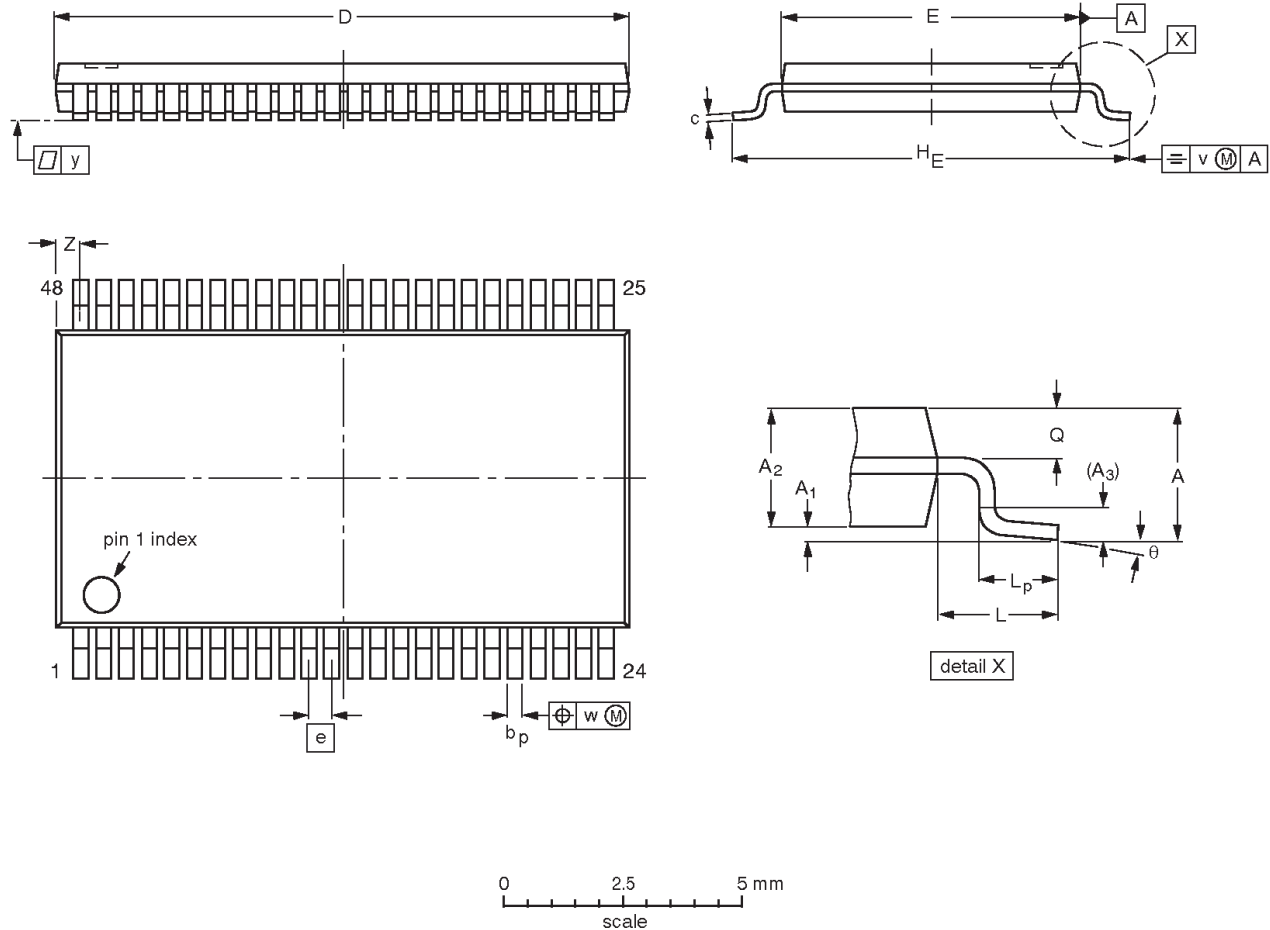


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TSSOP48: plastic thin shrink small outline package; 48 leads; body width 6.1mm

SOT362-1



DIMENSIONS (mm are the original dimensions).

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽²⁾	e	H _E	L	L _p	Q	v	w	y	Z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	12.6 12.4	6.2 6.0	0.5	8.3 7.9	1	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.8 0.4	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT362-1		MO-153ED				93-02-03 95-02-10

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Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.
Product specification	Production	This data sheet contains final specifications. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.

[1] Please consult the most recently issued datasheet before initiating or completing a design.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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Date of release: 12-98

Document order number:

9397-750-04949

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